

< Silicon RF Power MOS FET (Discrete) >

RD12MVS1

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 12W

DESCRIPTION

RD12MVS1 is a MOS FET type transistor specifically designed for VHF RF power amplifiers applications.

FEATURES

High Power Gain:

$P_{out} > 11.5W$, $G_p > 12dB @ V_{dd} = 7.2V, f = 175MHz$

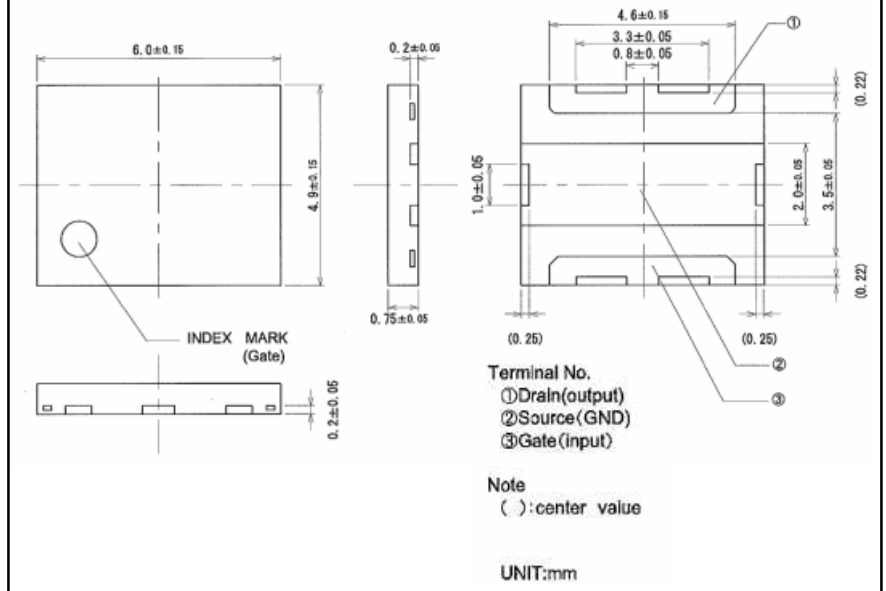
High Efficiency: 57%typ. (175MHz)

Integrated gate protection diode.

APPLICATION

For output stage of high power amplifiers in VHF band mobile radio sets.

OUTLINE DRAWING



RoHS COMPLIANT

RD12MVS1 is a RoHS compliant product.

RoHS compliance is indicating by the letter "G" after the Lot Marking.

ABSOLUTE MAXIMUM RATINGS

($T_c = 25^\circ C$, UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
V_{DSS}	Drain to Source Voltage	$V_{GS} = 0V$	50	V
V_{GSS}	Gate to Source Voltage	$V_{DS} = 0V$	-5/+10	V
I_D	Drain Current	-	4	A
P_{in}	Input Power	$Z_g = Z_l = 50\Omega$	2	W
P_{ch}	Channel Dissipation	$T_c = 25^\circ C$	50	W
T_j	Junction Temperature	-	150	$^\circ C$
T_{stg}	Storage Temperature	-	-40 to +125	$^\circ C$
R_{thj-c}	Thermal Resistance	Junction to Case	2.5	$^\circ C/W$

Note: Above parameters are guaranteed independently.

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ELECTRICAL CHARACTERISTICS (Tc=25°C, UNLESS OTHERWISE NOTED)

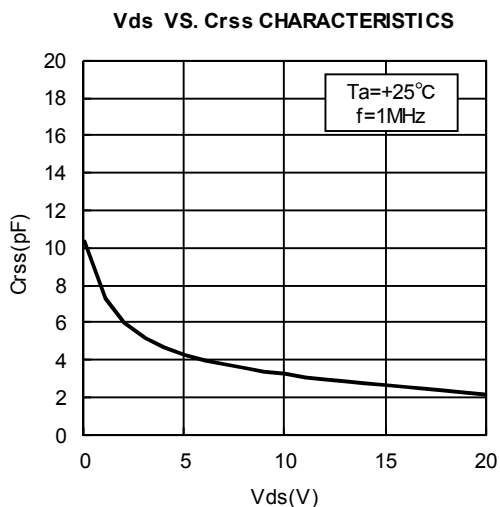
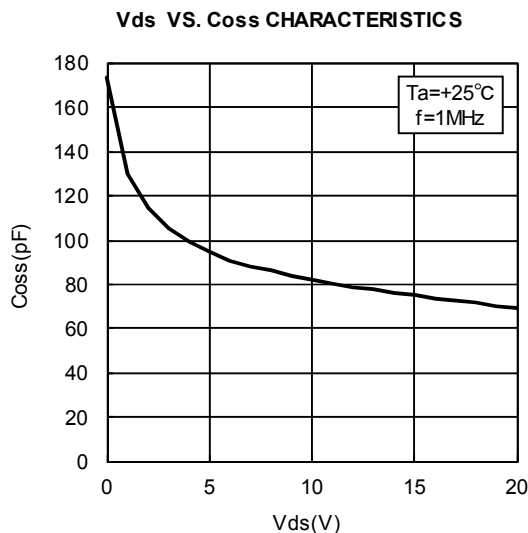
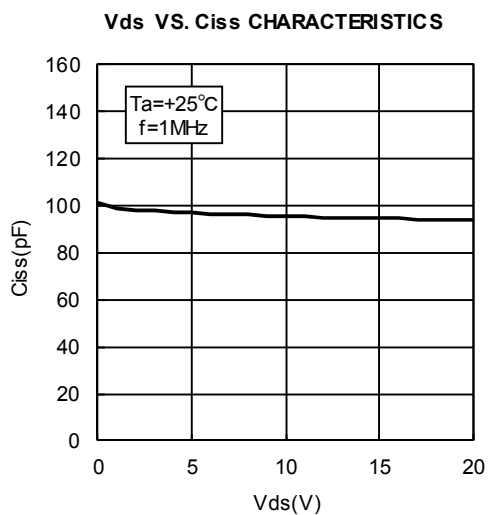
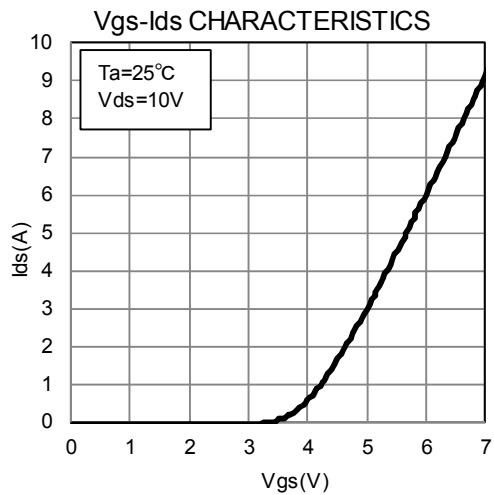
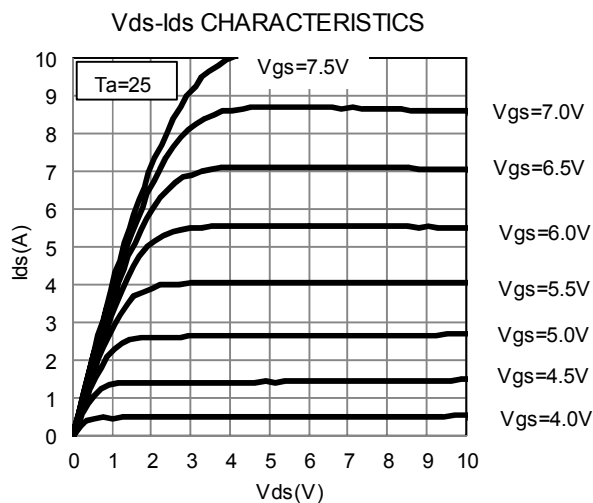
SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			MIN.	TYP.	MAX.	
Idss	Zero Gate Voltage Drain Current	VDS=17V, VGS=0V	-	-	10	uA
Igss	Gate to Source Leak Current	VGS=10V, VDS=0V	-	-	1	uA
VTH	Gate Threshold Voltage	VDS=12V, IDS=1mA	1.8	-	4.4	V
Pout	Output Power	f=175MHz, VDD=7.2V	11.5	12	-	W
η D	Drain Efficiency	Pin=1.0W, Idq=1.0A	55	57	-	%
	Load VSWR tolerance	VDD=9.2V, Po=12W(Pin Control) f=175MHz, Idq=1.0A, Zg=50Ω Load VSWR=20:1(All Phase)	Not destroy			-

Note: Above parameters, ratings, limits and conditions are subject to change.

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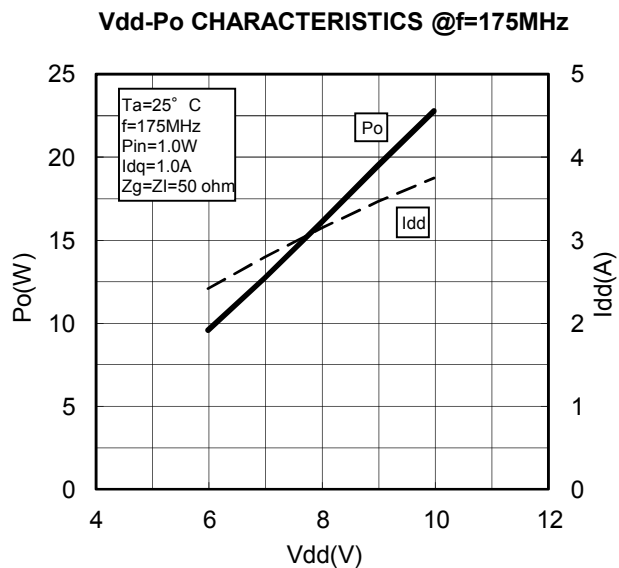
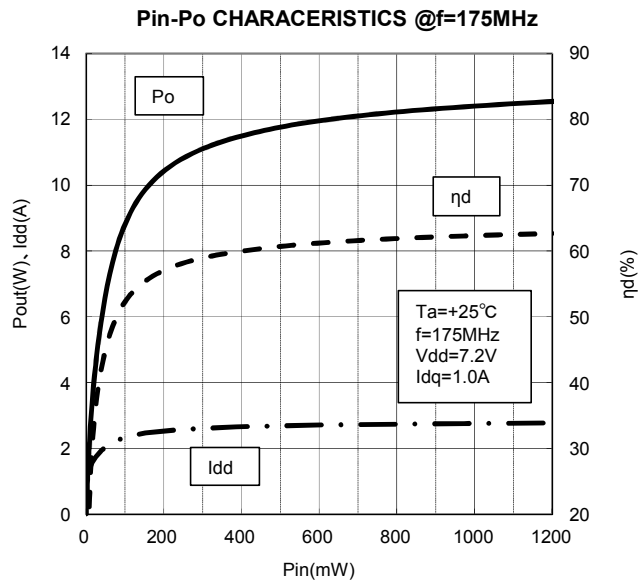
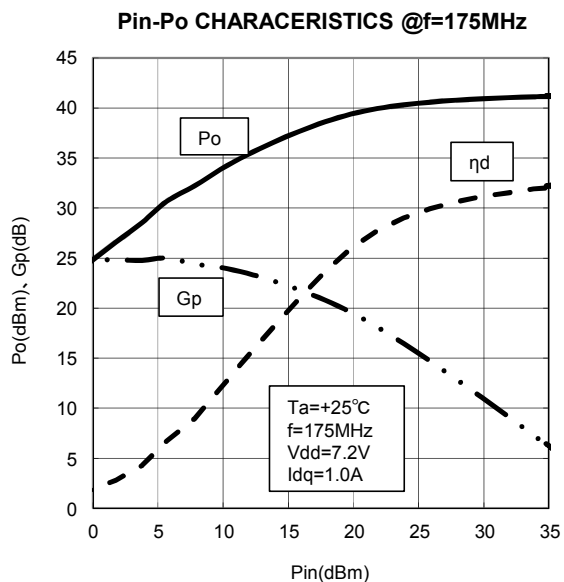
TYPICAL CHARACTERISTICS



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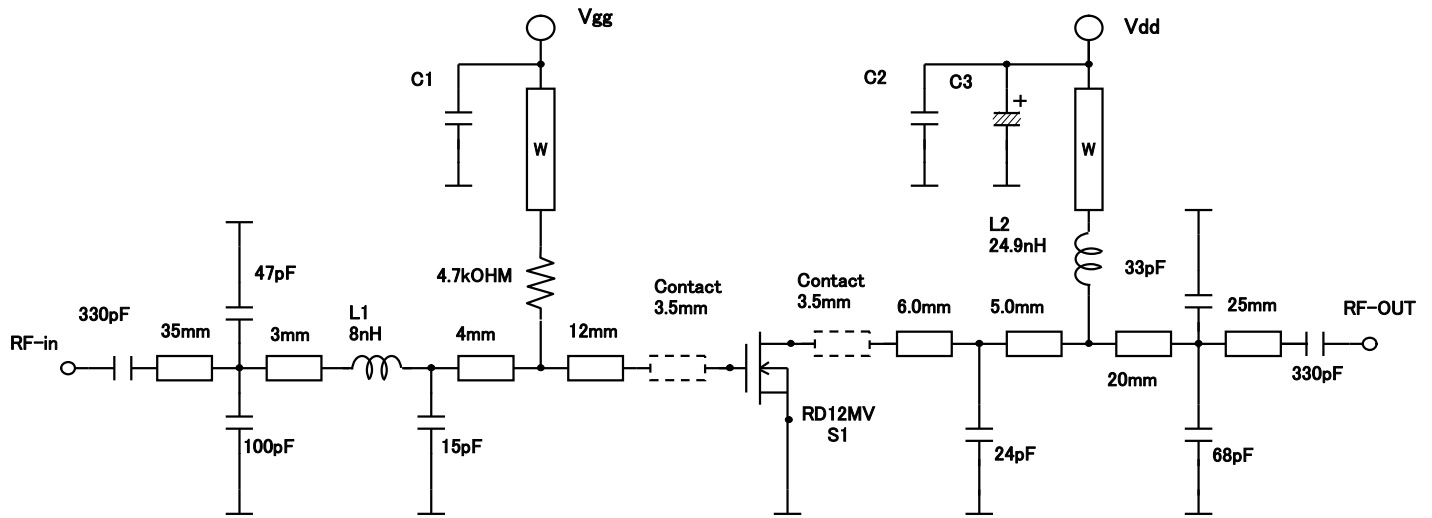
TYPICAL CHARACTERISTICS



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TEST CIRCUIT (f=175MHz)

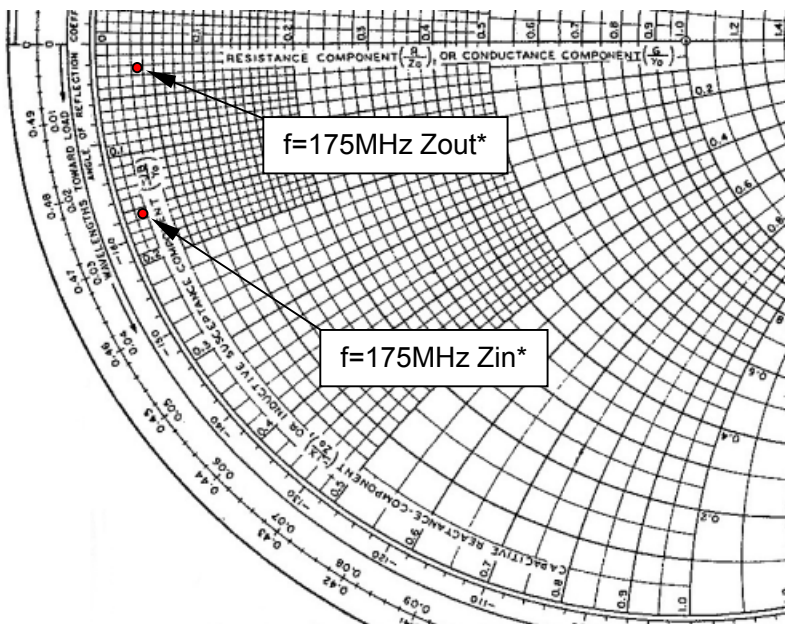


Note: Board material PTFE substrate
 Micro strip line width=2.2mm/50, er:2.7, t=0.8mm
 W: Line width=1.0mm
 Chip Condenser : GRM40
 --- Copper Board spring t=0.1mm

L: Enameled Wire
 L1: 4Turns, D: 0.43mm, ϕ 1.66mm (outside diameter)
 L2: 6Turns, D: 0.43mm, ϕ 2.46mm (outside diameter)
 C1, C2: 1000pF
 C3: 10 μ F, 50V

INPUT / OUTPUT IMPEDANCE VS. FREQUENCY CHARACTERISTICS

175MHz Z_{in}^* Z_{out}^*
 $Z_0=50\Omega$



Vdd=7.2V, Idq=1.0A (Vgg adj.), Pin=1.0W

$Z_{in}^*=0.965-j7.73$
 $Z_{out}^*=1.73-j1.14$

Z_{in}^* : Complex conjugate of input impedance
 Z_{out}^* : Complex conjugate of output impedance

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RD12MVS1 S-PARAMETER DATA (@Vdd=12.5V, Id=1.0A)

Freq. [MHz]	S11		S21		S12		S22	
	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
25	1.054	-11.4	17.086	-131.5	0.001	102.9	0.883	169.4
50	1.541	-42.0	93.038	-155.2	0.011	114.5	0.798	80.1
75	1.522	-82.5	102.995	160.8	0.018	71.7	0.586	-11.3
100	1.261	-106.9	84.221	136.0	0.019	46.9	0.577	-71.6
125	1.117	-118.4	71.094	125.1	0.019	35.4	0.599	-96.0
150	0.994	-128.5	58.269	115.8	0.019	26.1	0.627	-114.9
175	0.930	-134.5	50.406	110.3	0.019	20.7	0.644	-124.9
200	0.874	-140.5	42.557	104.9	0.019	15.6	0.656	-133.7
225	0.845	-143.9	38.111	101.7	0.019	12.0	0.665	-138.4
250	0.821	-147.1	33.867	98.6	0.019	8.7	0.671	-142.7
300	0.796	-150.9	28.814	94.5	0.019	5.1	0.679	-147.4
325	0.784	-153.1	25.786	91.9	0.018	2.3	0.686	-150.1
350	0.776	-154.8	23.568	89.8	0.018	0.1	0.690	-152.2
375	0.773	-155.4	22.607	88.8	0.018	-0.5	0.692	-152.7
400	0.768	-156.6	20.864	87.0	0.018	-2.8	0.695	-154.2
425	0.765	-157.7	19.360	85.3	0.018	-4.1	0.699	-155.3
450	0.764	-158.1	18.677	84.5	0.018	-4.8	0.701	-155.8
475	0.762	-159.1	17.132	82.6	0.018	-7.1	0.705	-157.0
500	0.762	-159.7	16.409	81.5	0.018	-7.9	0.707	-157.5
550	0.761	-160.5	15.078	79.6	0.018	-9.8	0.712	-158.4
600	0.763	-161.5	13.430	76.9	0.018	-12.1	0.721	-159.5
650	0.766	-162.2	12.272	74.7	0.017	-14.2	0.726	-160.2
700	0.769	-162.8	11.210	72.6	0.017	-16.2	0.733	-160.8
750	0.771	-163.1	10.735	71.6	0.017	-17.4	0.736	-161.1
800	0.775	-163.6	9.876	69.5	0.017	-19.1	0.743	-161.5
850	0.780	-164.0	9.064	67.6	0.017	-20.7	0.750	-162.1
900	0.784	-164.3	8.609	66.3	0.016	-22.0	0.755	-162.4
950	0.790	-164.8	7.787	63.8	0.016	-24.5	0.765	-162.9
1000	0.794	-165.0	7.432	62.7	0.016	-25.8	0.769	-163.0

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ATTENTION:

1. High Temperature ; This product might have a heat generation while operation, Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
2. Generation of High Frequency Power ; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
3. Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
2. RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products , please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of $T_{chmax}=150deg/C$), 140deg/C(in case of $T_{chmax}=175deg/C$) under standard conditions.
6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.

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10. Please avoid use in the place where water or organic solvents can adhere directly to the product and the environments with the possibility of caustic gas, dust, salinity, etc. Reliability could be markedly decreased and also there is a possibility failures could result causing a serious accident. Likewise, there is a possibility of causing a serious accident if used in an explosive gas environment. Please allow for adequate safety margin in your designs.

11. Please refer to the additional precautions in the formal specification sheet.

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

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